

PARA LIGHT ELECTRONICS CO., LTD.

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DATA SHEET

PART NO.: L-C155TBJSCT-5A

REV: <u>A/0</u>

CUSTOMER'S APPROVAL:

DRAWING NO.: DS-31-09-XXXX

DATE: 2009-06-30

DCC:

PARA-FOR-065

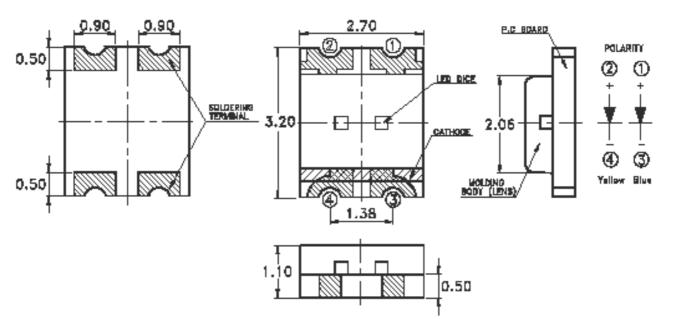
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Part No.: L-C155TBJSCT-5A

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• PACKAGE OUTLINE DIMENSIONS



Notes:

1. 24: Yellow; 13:Blue

2. All dimensions are in millimeters.

3. Tolerance is \pm 0.1mm (.004") unless otherwise noted.

• Features

- * Dual color, top view, wide view angle Chip LED.
- * Package in 8mm tape on 7" diameter reels.
- * Compatible with automatic Pick & Place equipment.
- * Compatible with Reflow soldering and Wave soldering processes.
- * EIA STD package.
- * I.C. compatible.
- * Pb free product.

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Release by PARA LIGHT DCC



SURFACE MOUNT DEVICE LED

Part No.: L-C155TBJSCT-5A

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• Chip Materials

Chip	Light Color	Dice Material	Lens Color
13	TB:Blue	InCaN	Watan Claan
24	JS: Yellow	AllnCaP	Water Clear

• Absolute Maximum Ratings (Ta= 25° C)

Sumbol	Parameter	Ra	Unit		
Symbol	Farameter	Blue	Yellow	Unit	
PD	Power Dissipation	76	76 75		
IPF	Peak Forward Current		80	mΛ	
IPF	(1/10 Duty Cycle, 0.1ms Pulse Width)	100	80	mA	
IF	Continuous Forward Current	20 30		mA	
-	De-rating Linear From $25^{\circ}C$	0.25	0.4	mA/°C	
VR	Reverse Voltage	5 5		V	
ESD	Electrostatic Discharge Threshold (HBM) ^{Note A}	2000			
Topr	Operating Temperature Range	-20 ~ +80		°C	
Tstg	Storage Temperature Range	-30 ~ +100		°C	
-	Wave Soldering Condition (Two times Max.)	260 (for 5 seconds)		°C	
-	Infrared Soldering Condition (Two times MAX.)	260 (for 10 seconds)		°C	

Note A:

HBM: Human Body Model. Seller gives no other assurances regarding the ability of to withstand ESD.

• Electro-Optical Characteristics (Ta=25°C)

Parameter		Symbol	Blue	Yellow	Unit	Test Condition	
	Min.		4.5	4.5			
Luminous Intensity	Тур.	IV			mcd	IF=5mA	
	Max.		45.0	45.0			
Viewing Angle	Тур.	$2 \theta 1/2$	130		deg	Note 2	
Peak Wavelength	Тур.	λp	468	591	nm	Measurement @Peak	
Dominant Wavelength	Тур.	λd	470	589	nm	IF=5mA	
Spectral Line Half-Width	Тур.	Δλ	25	15	nm		
Forward Voltage	Тур.	VF	3.1	2.0	v	IF =5mA	
Forward voltage	Max.	V I	3.6	2.4	v	IF –JIIIA	
Reverse Current	Max.	IR	10		μA	VR = 5V	
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Part No.: L-C155TBJSCT-5A

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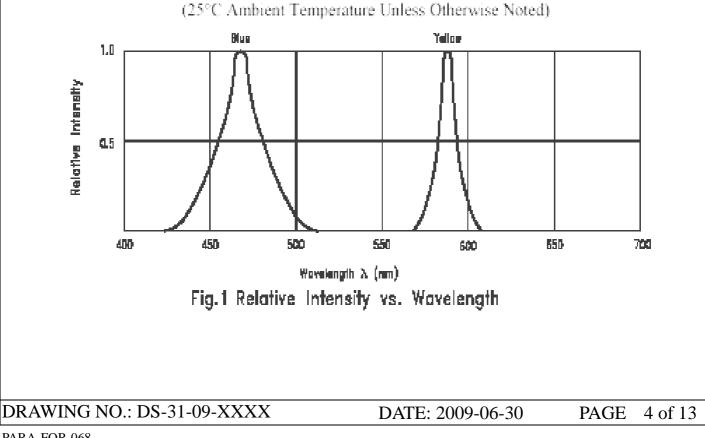
Notes:

- 1. Luminous intensity is measured with a light sensor and filter combination that proximities the CIE eye-response curve.
- 2. $\theta_{1/2}$ is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- 3. The dominant wavelength λ d is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.
- 4. Caution in ESD:

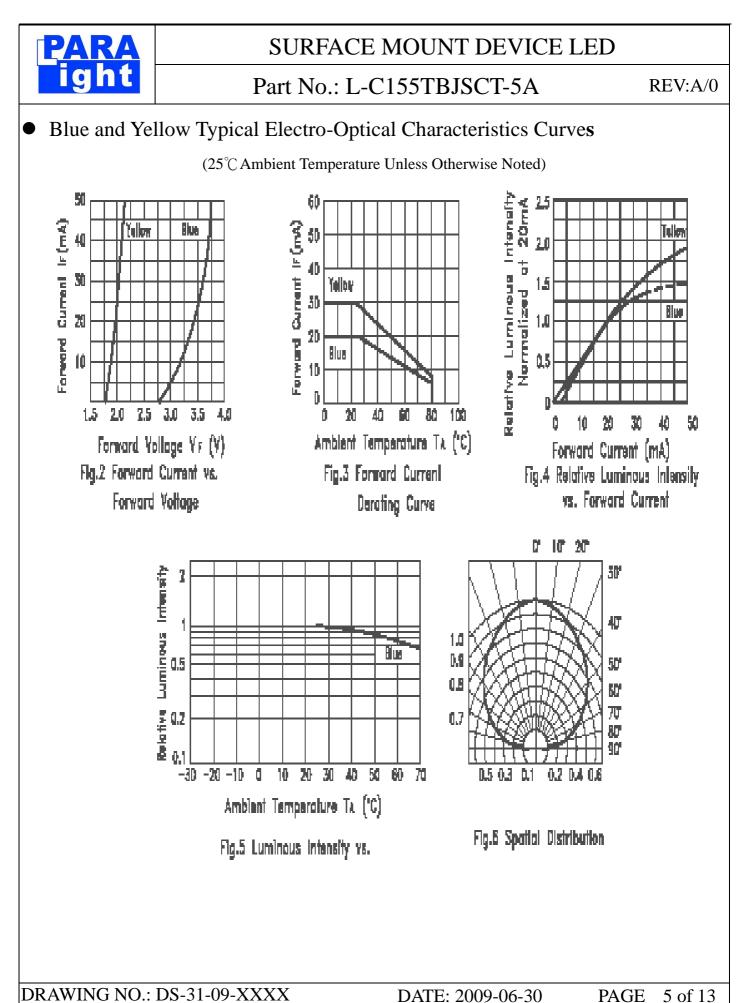
Static Electricity and surge damages the LED. It is recommended use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.

5. Major standard testing equipment by "Instrument System" Model: CAS140B Compact Array Spectrometer and "KEITHLEY" Source Meter Model: 2400.

Typical Electro-Optical Characteristics Curves







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Label Explanation

SURFACE MOUNT DEVICE LED

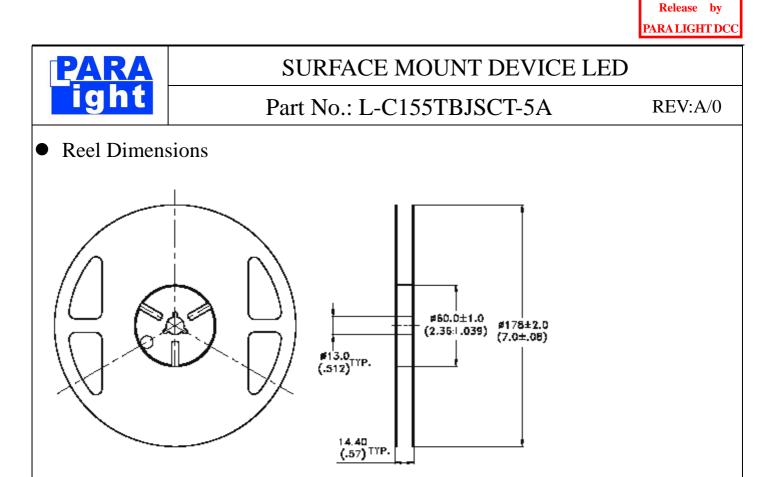
Part No.: L-C155TBJSCT-5A

REV:A/0

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CUS. PART NO: To be denominated. CUSTOMER: To be denominated. PART NO: Refer to P15 **BATCH: MNGA** M--- a Chip Luminous Intensity Code N--- b Chip Luminous Intensity Code GA--- a Chip Dominant Wavelength Code 7 0009 LOT NO: E L S 4 А BCDE F A---E: For series number B---L: Local F: Foreign C---S: SMD D----Year E---Month F---SPEC. **QUANTITY:** 3000pcs for 150, 110, 155, 115, 195 series 4000pcs for 191 series 5000pcs for 192 series

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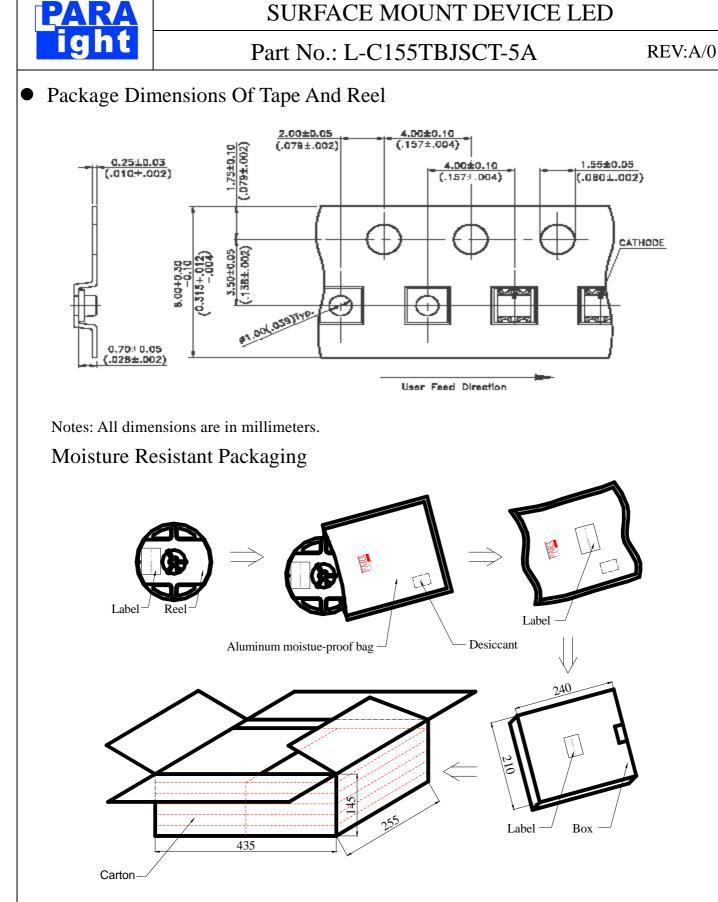


Notes:

- 1. Empty component pockets sealed with top cover tape.
- 2. 7 inch reel-3000 pieces per reel.
- 3. Minimum packing quantity is 500 pcs for remainders.
- 4. The maximum number of consecutive missing lamps is two.
- 5. In accordance with ANSI/EIA 481-1-A-1994 specifications.

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Notes: One reel in a bag, one bag in a inner box, ten inner boxes in a carton. Unit: mm. DRAWING NO.: DS-31-09-XXXX DATE: 2009-06-30 PAGE

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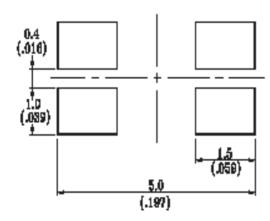
Part No.: L-C155TBJSCT-5A

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• Cleaning

- * If cleaning is required , use the following solutions for less than 1 minute and less than 40° C.
- * Appropriate chemicals: Ethyl alcohol and isopropyl alcohol.
- Effect of ultrasonic cleaning on the LED resin body differs depending on such factors as the oscillator output, size of PCB and LED mounting method. The use of ultrasonic cleaning should be enforced at proper output after confirming there is no problem.

Suggest Soldering Pad Dimensions

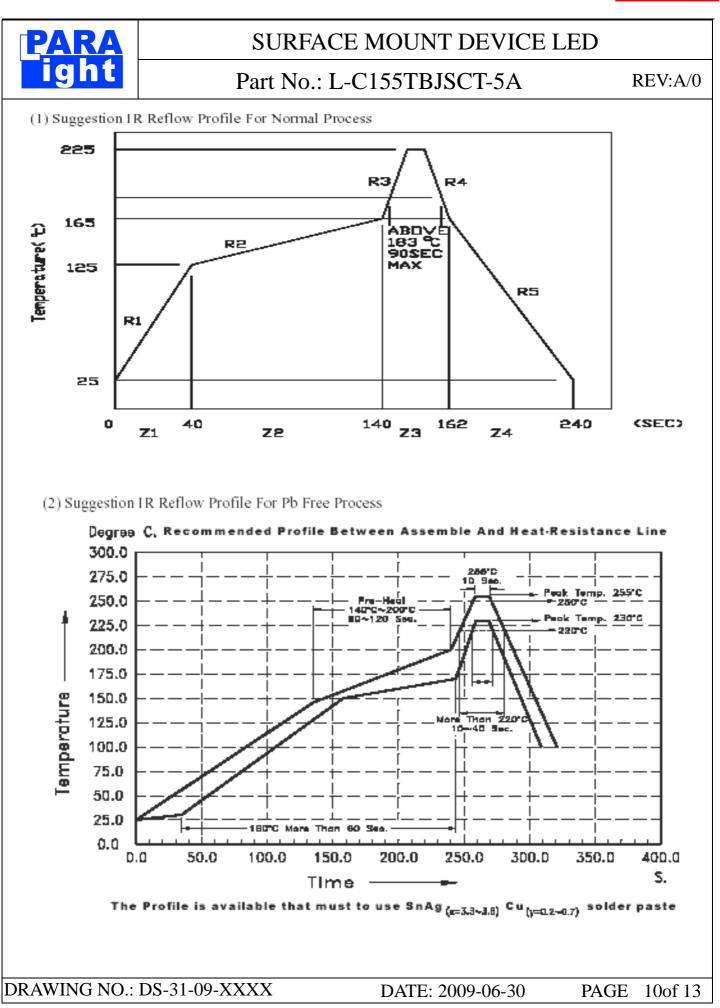


Direction of PWB camber and go to reflow furnace

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Release by PARA LIGHT DCC

PARA-FOR-068



Part No.: L-C155TBJSCT-5A

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Release by PARA LIGHT DCO

• Bin Code List

Luminous Intensi	ity Color : <u>Blue</u> , U	Color : Blue , Unit : mcd @5mA		
Bin Code	Min.	Max.		
1	4.50	7.10		
К	7.10	11.20		
L	11.20	18.00		
М	18.00	28.00		
Ν	28.00	45.00		

Luminous Intensity	y Color : <u>Yellow</u> ,	Unit : mcd @5mA
Bin Code	Min.	Max.
1	4.50	7.10
К	7.10	11.20
L	11.20	18.00
М	18.00	28.00
Ν	28.00	45.00

Tolerance on each Intensity bin is +/-15%

Tolerance on each Intensity bin is +/-15%

CAUTIONS

1. Application Limitation:

The LED's described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household application). Consult PARA's sales in advance for information on application in which exceptional quality and reliability are required, particularly when the failure or malfunction of the LED's may directly jeopardize life or health (such as airplanes, automobiles, traffic control equipment, life support system and safety devices).

2.Storage:

Before opening the package:

The LEDs should be kept at 5° C to 30° C or less and 85%RH or less. The LEDs should be used within a year.

After opening the package:

The LEDs should be kept at 5°C to 30°C or less and 70%RH or less. The LEDs should be soldered within 168 hours (7 days) after opening the package.

Please avoid rapid transitions in ambient temperature in high humidity environments where condensation may occur.

3.Soldering

Do not apply any stress to the lead frame during soldering while the LED is at high temperature.

Recommended soldering condition.

Reflow Soldering:

Pre-heat 120~150°C, 120sec. MAX., Peak temperature : 240°C Max. Soldering time: 10 sec Max.

Soldering Iron: (Not recommended)

Temperature 300°C Max., Soldering time : 3 sec. Max.(one time only), power dissipation of iron : 20W Max. use SN60 solder of solder with silver content and don't to touch LED lens when soldering.

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Wave soldering:

Pre-heat 100°C Max, Pre-heat time 60 sec. Max, Solder wave 260°C Max, Soldering time 5 sec. Max. preformed consecutively cooling process is required between 1st and 2nd soldering processes.

4. Lead-Free Soldering

For Reflow Soldering:

- 1 Pre-Heat Temp:150-180°C,120sec.Max.
- 2 Soldering Temp: Temperature Of Soldering Pot Over 230°C,40sec.Max.
- $3 \cdot \text{Peak Temperature:} 260^\circ \text{C}$, 5 sec.
- 4 Reflow Repetition:2 Times Max.
- 5 · Suggest Solder Paste Formula 93.3 Sn/3.1 Ag/3.1 Bi /0.5 Cu

For Soldering Iron (Not Recommended):

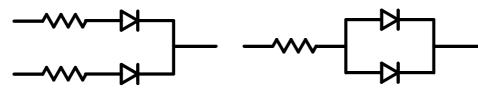
- 1 S Iron Tip Temp:350℃ Max.
- 2 Soldering Iron:30w Max.
- 3 Soldering Time:3 Sec. Max. One Time.

For Dip Soldering:

- 1 Pre-Heat Temp:150°C Max. 120 Sec. Max.
- $2 \cdot Bath Temp: 265^{\circ}C Max.$
- 3 Dip Time:5 Sec. Max.
- 5. Drive Method

Circuit model A

Circuit model B



(A)Recommended circuit.

(B)The difference of brightness between LED's could be found due to the Vf-If characteristics of LED.

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6.Reliability Test

Classification	Test Item	Test Condition	Reference Standard
Endurance Test	Operation Life	Ta= Under Room Temperature As Per Data Sheet Maximum Rating *Test Time= 1000HRS (-24HRS,+72HRS)*@20mA.	MIL-STD-750D: 1026 (1995) MIL-STD-883D: 1005 (1991) JIS C 7021:B-1 (1982)
	High Temperature High Humidity Storage	IR-Reflow In-Board, 2 Times Ta= 65±5°C,RH= 90~95% *Test Time= 1000HRS±2HRS	MIL-STD-202F: 103B(1980) JIS C 7021: B-11 (1982)
	High Temperature Storage	Ta= 105±5°C Test Time= 1000HRS (-24HRS, 72HRS)	MIL-STD-883D: 1008 (1991) JIS C 7021:B-10 (1982)
	Low Temperature Storage	Ta= -55±5℃ *Test Time=1000HRS (-24HRS, 72H RS)	JIS C 7021:B-12 (1982)
Environmental Test	Temperature Cycling	105±5℃ -55±5℃ 10mins 10mins 100 Cycles	MIL-STD-202F: 107D (1980) MIL-STD-750D: 1051(1995) MIL-STD-883D: 1010 (1991) JIS C 7021: A-4 (1982)
	Thermal Shock	IR-Reflow In-Board, 2 Times105±5℃-55℃±5℃10mins10mins100 Cycles	MIL-STD-202F: 107D(1980) MIL-STD-750D: 1051(1995) MIL-STD-883D: 1011(1991)
	Solder Resistance	Tsol= $260 \pm 5^{\circ}$ C Dwell Time= 10 ± 1 sec	MIL-STD-202F: 210A(1980) MIL-STD-750D: 2031(1995) JIS C 7021: A-1 (1982)
	Solder ability	Tsol= $235 \pm 5^{\circ}$ C Immersion time 2 ± 0.5 sec Immersion rate 25 ± 2.5 mm/sec Coverage $\geq 95\%$ of the dipped surface	MIL-STD-202F: 208D(1980) MIL-STD-750D: 2026(1995) MIL-STD-883D: 2003(1991) IEC 68 Part 2-20 JIS C 7021: A-2 (1982)

7.Others:

The appearance and specifications of the product may be modified for improvement without notice.

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